ASC30N1200MT3

V X / Mob:15919711751

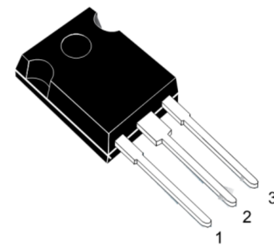
1200V N-Channel MOSFET

Description

Silicon Carbide (SiC) MOSFET use a completely new technology that provide superior switching performance and higher reliability compared to Silicon. In addition, the low ON resistance and compact chip size ensure low capacitance and gate charge. Consequently, system benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size.

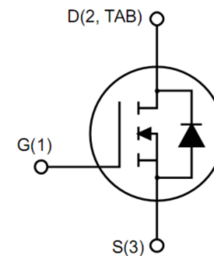
Features

- High Speed Switching with Low Capacitances
- High Blocking Voltage with Low RDS(on)
- Simple to drive with Standard Gate Drive
- 100% avalanche tested
- Maximum junction temperature of 150°C
- ROHS Compliant



Application

- EV Charging
- DC-AC Inverters
- High Voltage DC/DC Converters
- Switch Mode Power Supplies
- Power Factor Correction Modules
- Motor Drives



Ordering Information

Part Number	Marking	Package	Packaging
ASC30N1200MT3	ASC30N1200MT3	TO-247	Tube

Absolute Maximum Ratings(Tc=25℃)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage	1200	V
I_D	Drain Current(continuous)at Tc=25℃	30	A
I_D	Drain Current(continuous)at Tc=100℃	20	A
I_{DM}	Drain Current (pulsed)	90	A
V_{GS}	Gate-Source Voltage Operation	-10/+25	V
P_D	Power Dissipation T_C = 25°C	208	W
T_J, Tstg	Junction and Storage Temperature Range	-55 to +150	℃

Electrical Characteristics(T_J = 25℃ unless otherwise specified)

Typical Performance-Static

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BV_{DS}	Drain-source Breakdown Voltage	I_D=250uA,V_{GS}=0V	1200			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} =1200V, V_{GS} =0V, T_J=25°C			100	uA
I_{GSS}	Gate-body Leakage Current	V_{DS} =0V ; V_{GS} =-10 to 20V			250	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}= V_{GS}, I_D=5mA	2	3	4	V
$R_{DS(on)}$	Static Drain-source On Resistance	V_{GS}=20V, I_D=30A		80	100	mΩ
R_G	Gate Resistance	V_{GS}=0V,f=1MHz		5		Ω

Typical Performance-Dynamic

C_{iss}	Input Capacitance	V_{DS}=400V,f=1MHz,V_{GS}=0V		1290		pF
C_{oss}	Output Capacitance			130		pF
C_{rss}	Reverse Transfer Capacitance			32		pF
Q_g	Total Gate Charge	V_{DS}=800V, I_D=20A,V_{GS}=0~20V		106		nC
Q_{gs}	Gate-source Charge			18		nC
Q_{gd}	Gate-Drain Charge			38		nC
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=800V,ID=30A, V_{GS}=-0V~20V, R_G=0Ω,		20		ns
t_r	Rise Time			25		ns
$t_{d(off)}$	Turn-off Delay Time			46		ns
t_f	Fall Time			22		ns

Typical Performance-Reverse Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{FSD}	Forward Voltage	V_{GS}=0V,I_F=30A,T_J=25°C	3		6	V
		V_{GS}=0V,I_F=30A,T_J=150°C	3		6	V
t_{rr}	Reverse Recovery Time	V_{GS}=0 V, I_F=30 A, V_R=800 V, d*i*/d*t*= 100 A/μs		140		ns
Q_{rr}	Reverse Recovery Charge			150		nC
I_{rrm}	Peak Reverse Recovery Current			5		A

Thermal Characteristics

Symbol	Parameter	Value.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Case	40	°C/W

The values are based on the junction-to case thermal impedance which is measured with the device mounted to a large heat sink assuming maximum junction temperature of Tj(max)=150℃

Electrical Characteristics

Figure 1: Output characteristics (T_J = 25 °C)

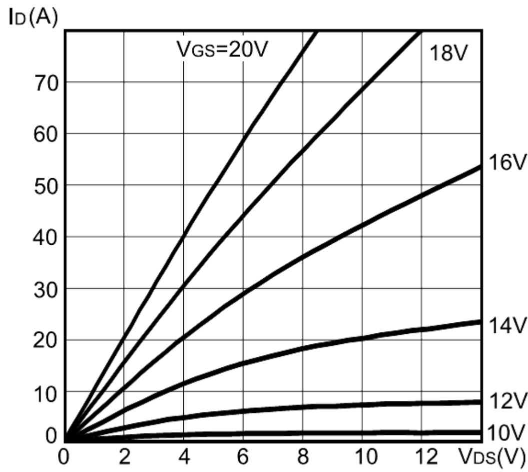


Figure 2: Output characteristics (T_J = 150 °C)

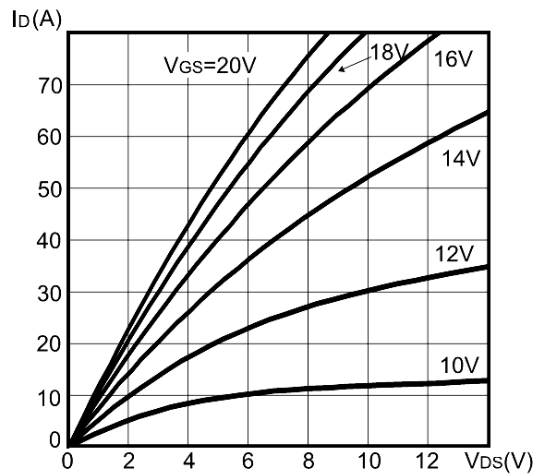


Figure 3: Transfer characteristics

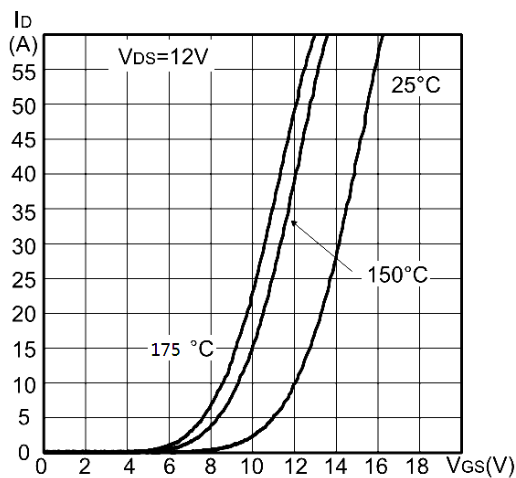


Figure 4 Normalized BVDSS vs. Temperature

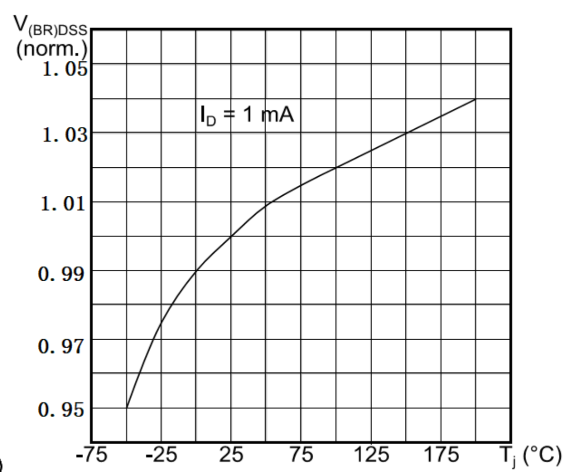


Figure 5: Power dissipation

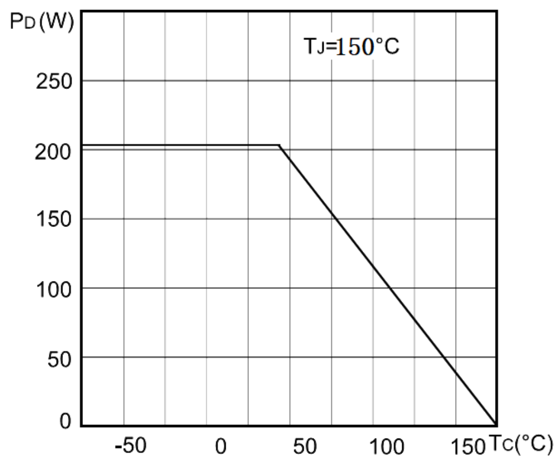


Figure 6: Gate charge vs gate-source voltage

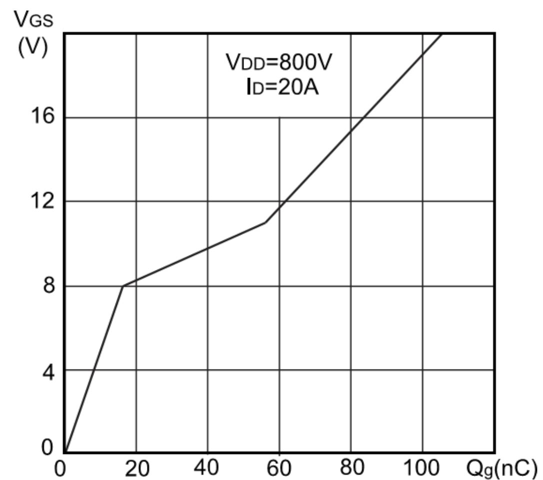


Figure 7: Capacitance variations

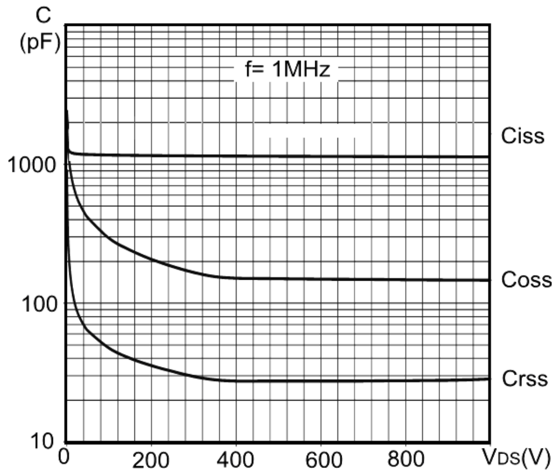


Figure 8: Switching energy vs. drain current

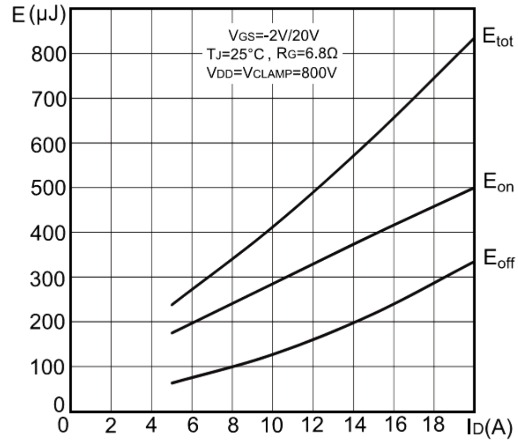


Figure 9: Normalized Vth vs. T_J

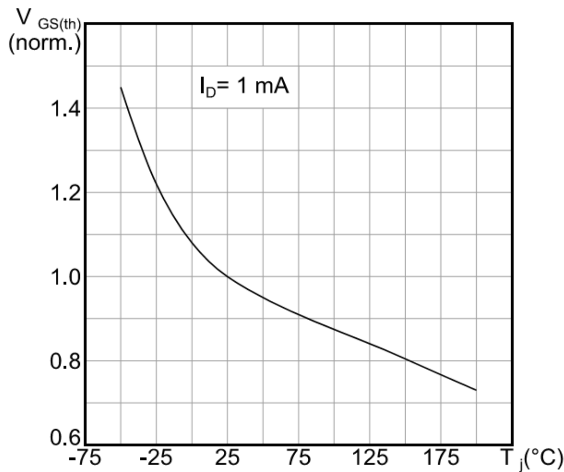


Figure 10: Normalized Rdson vs. T_J

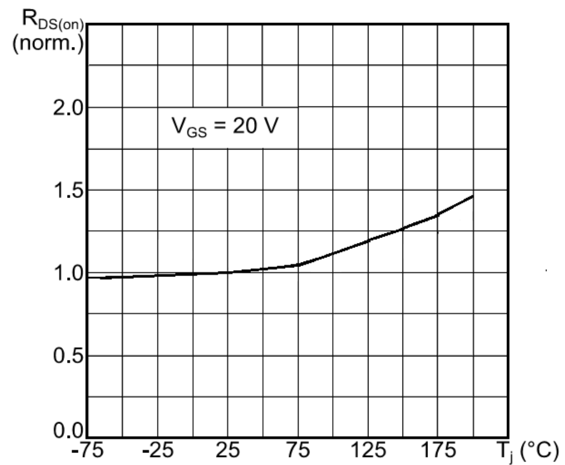


Figure 11: Body diode characteristics (T_J = 25 °C)

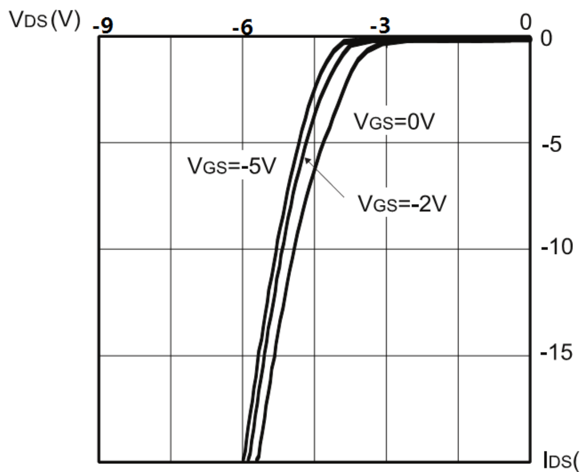


Figure 12: Body diode characteristics (T_J =150 °C)

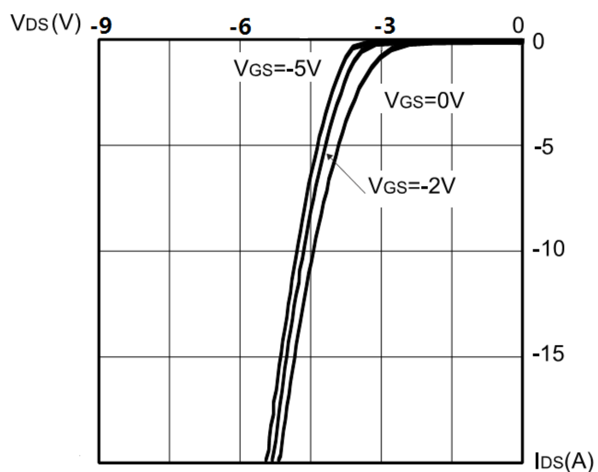


Figure 13: 3rd quadrant characteristics (T_J = 25 °C)

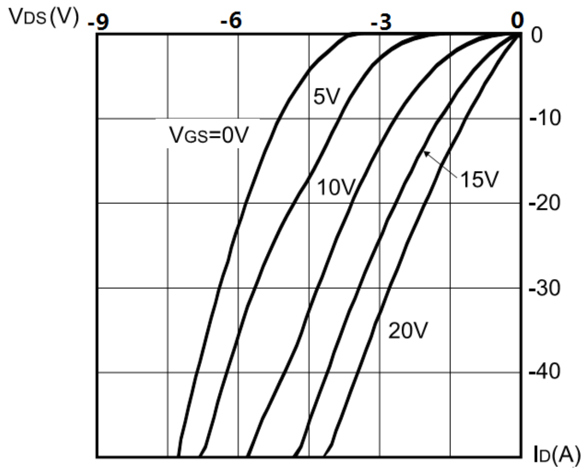


Figure 14: 3rd quadrant characteristics (T_J = 150°C)

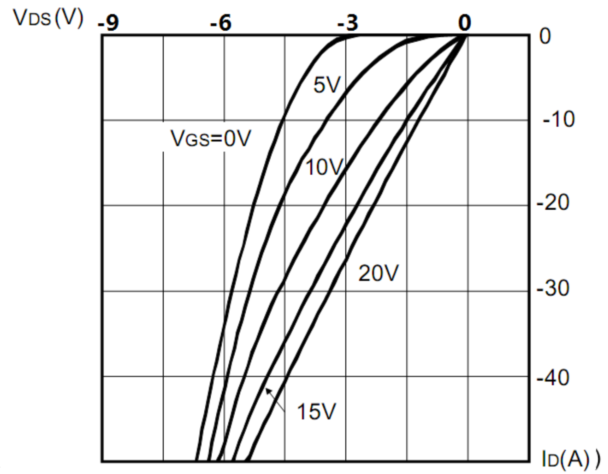


Figure 15: Safe operating area

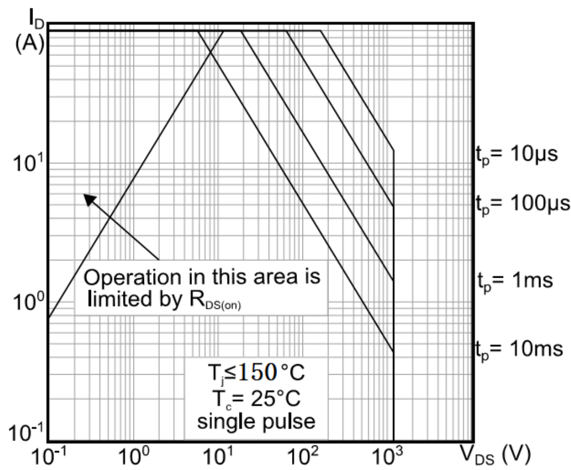
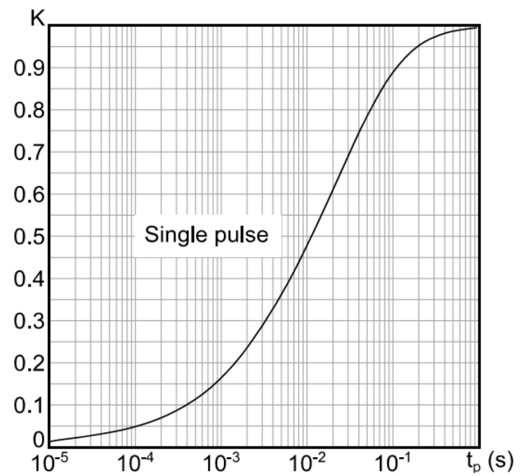
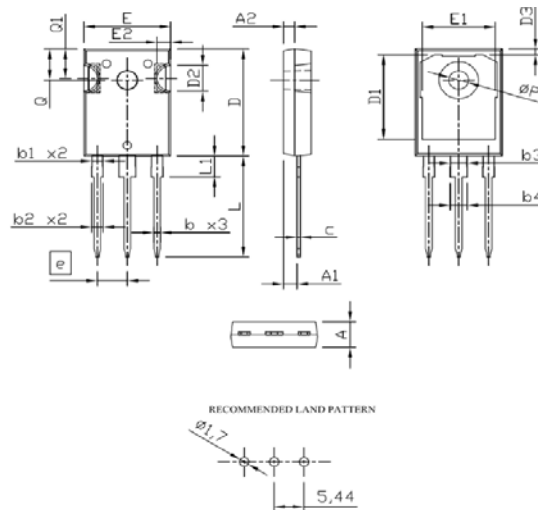


Figure 16: Thermal impedance



Package Drawing:



Dimensions（ UNIT：mm）

SYMBDLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	4.90	5.00	5.10	0.193	0.197	0.201
A1	2.31	2.42	2.52	0.091	0.095	0.099
A2	1.90	2.00	2.10	0.075	0.079	0.083
b	1.16	1.22	1.27	0.046	0.048	0.050
b1	1.96	2.02	2.07	0.078	0.080	0.081
b2	2.00	2.10	2.20	0.079	0.083	0.087
b3	2.96	3.02	3.07	0.117	0.119	0.121
b4	3.00	3.10	3.20	0.118	0.122	0.126
C	0.59	0.62	0.66	0.023	0.024	0.026
D	20.90	21.00	21.10	0.823	0.827	0.831
D1	16.25	16.55	16.85	0.640	0.652	0.663
D2	5.00 TYP			0.197 TYP		
D3	1.05	1.20	1.35	0.041	0.047	0.053
e	5.44 BSC				0.214 BSC	
E	15.70	15.80	15.90	0.618	0.622	0.626
E1	13.06	13.26	13.50	0.514	0.522	0.530
E2	2.50 TYP				0.098 TYP	
L	19.72	19.92	20.12	0.776	0.784	0.792
L1	——	——	4.30	——	——	0.169
Q	6.15 BSC			0.242BSC		
Q1	5.60	5.80	6.00	0.220	0.228	0.236
ØP	3.55	3.60	3.70	0.140	0.142	0.146